

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	1390045
<b>Application Number:</b>	10049270
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	9445
<b>Title of Invention:</b>	MULTILAYER PRINTED WIRING BOARD, SOLDER RESIST COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER PRINTED WIRING BOARD, AND SEMICONDUCTOR DEVICE
<b>First Named Inventor/Applicant Name:</b>	Hui Zhong
<b>Customer Number:</b>	23373
<b>Filer:</b>	Todd B. Buck/Lelia Gilday
<b>Filer Authorized By:</b>	Todd B. Buck
<b>Attorney Docket Number:</b>	Q68281
<b>Receipt Date:</b>	20-DEC-2006
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<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	IDS.pdf	149395	no	5

**Warnings:**

<b>Information:</b>					
This is not an USPTO supplied IDS fillable form					
2	NPL Documents	EP_Office_Action.pdf	134386	no	5
<b>Warnings:</b>					
<b>Information:</b>					
3	Foreign Reference	EP0997935.pdf	1065709	no	22
<b>Warnings:</b>					
<b>Information:</b>					
4	Foreign Reference	GB2097998.pdf	366168	no	6
<b>Warnings:</b>					
<b>Information:</b>					
5	Foreign Reference	EP0919873.pdf	1100411	no	22
<b>Warnings:</b>					
<b>Information:</b>					
6	Foreign Reference	JP11012499.pdf	66551	no	2
<b>Warnings:</b>					
<b>Information:</b>					
7	Foreign Reference	JP09040751.pdf	72087	no	2
<b>Warnings:</b>					
<b>Information:</b>					
<b>Total Files Size (in bytes):</b>			2954707		

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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.